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PIANO NAZIONALE
DI RIPRESA E RESILIENZA



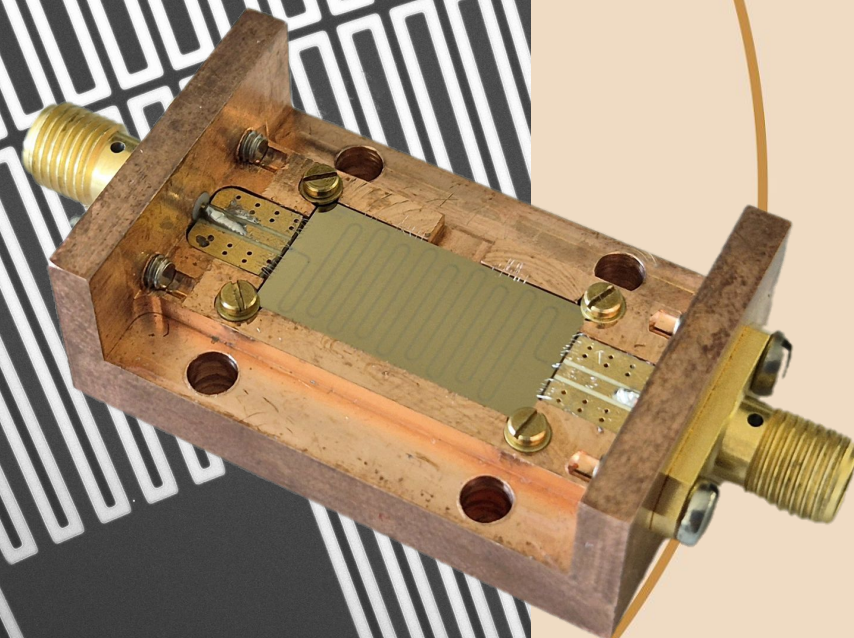
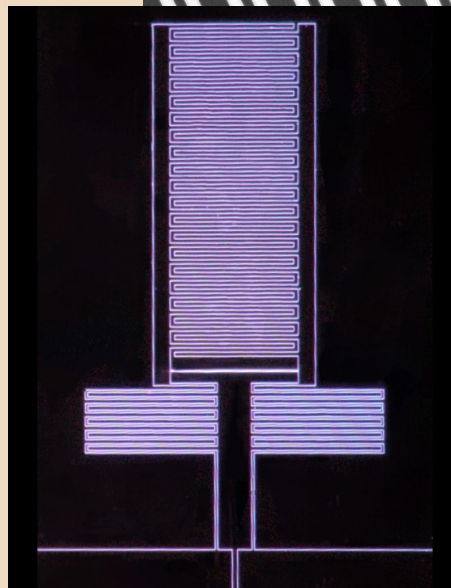
NQSTI
National Quantum Science
and Technology Institute

Development of superconducting high kinetic inductance devices

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Centre for Sensors and Devices

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Second NQSTI Congress, 5-7 February 2025, Rome



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The FBK team



From left to right:

- | | |
|------------------------------|----------------------------|
| Enrico Bogoni | - PhD student |
| Marcello Faggionato | - Master's student |
| Benno Margesin | - Senior fellow |
| Federica Mantegazzini | - Researcher & Team leader |
| Nicolò Crescini | - Researcher |
| Alessandro Irace | - PhD student |
| Felix Ahrens | - Researcher |



External collaborators in Trento:

Experimentalists: Paolo Falferi, Renato Mezzena, Andrea Vinante

Theoreticians: Iacopo Carusotto, Gianluca Rastelli, Stephanie Matern



Collaboration with [Milano Bicocca](#):

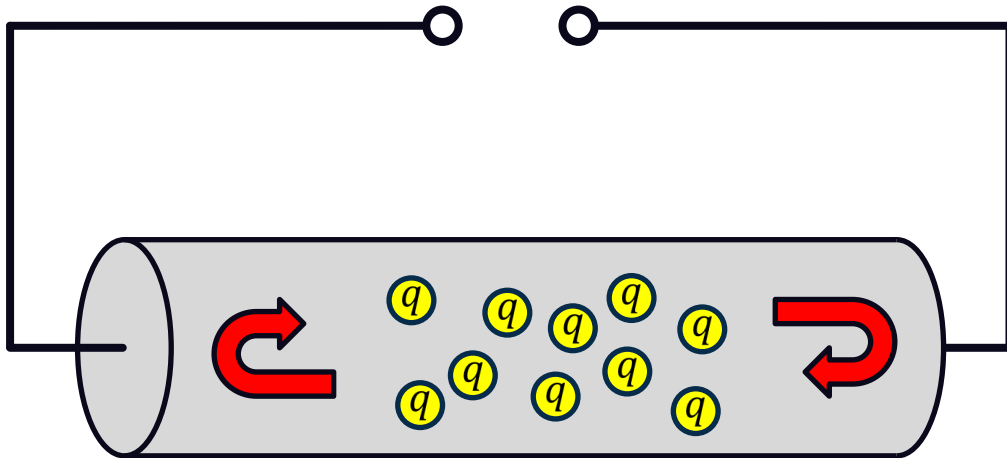
Andrea Giachero, Angelo Nucciotti,
Marco Faverzani and colleagues





High kinetic inductance films

$$U = U_0 e^{i\omega t}$$



$$\sigma = \frac{nq^2\tau}{m(1 + i\omega\tau)}$$

Kinetic inductance:

- large collision time τ
- high frequency ω

Superconductor:

$$\tau \rightarrow \infty, \quad m = 2m_e, \quad q = 2e$$

Cooper pair density $n = n(I)$

$$\Rightarrow L(I) \approx L_0 \cdot \left(1 + \frac{I^2}{I_*^2}\right)$$

$$L_0 = \frac{R_S \hbar}{\pi \Delta}$$

$$I_* \propto 1/\sqrt{R_n}$$



High kinetic inductance films

- Interesting materials:
high-resistivity superconductors
- Our choice: **NbTiN**
 - high resistivity ($\sim 100\text{--}200\text{ m}\Omega\text{cm}$)
 - high critical temperature ($\sim 12\text{--}13\text{ K}$)

Superconductor:

$$\tau \rightarrow \infty, \quad m = 2m_e, \quad q = 2e$$

Cooper pair density $n = n(I)$

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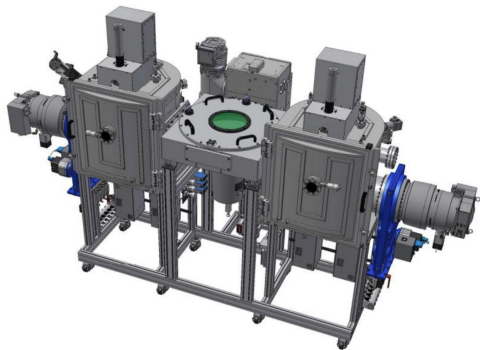
$$I_* \propto 1/\sqrt{R_n}$$



Optimisation of NbTiN thin films: parameter exploration

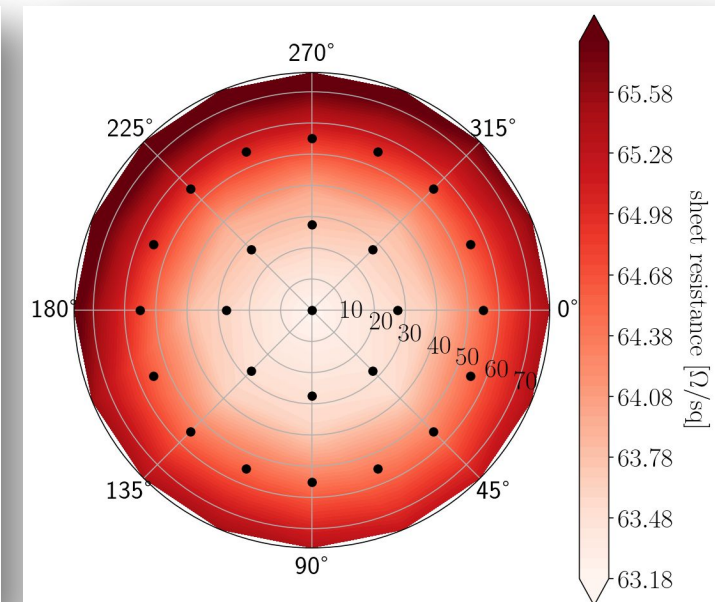
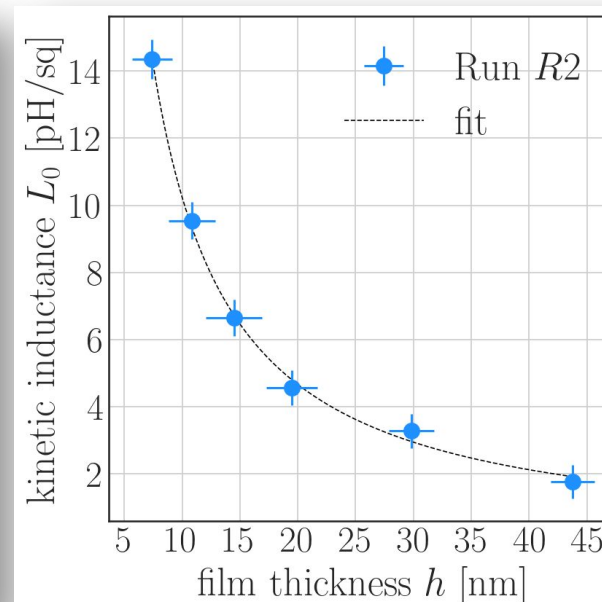
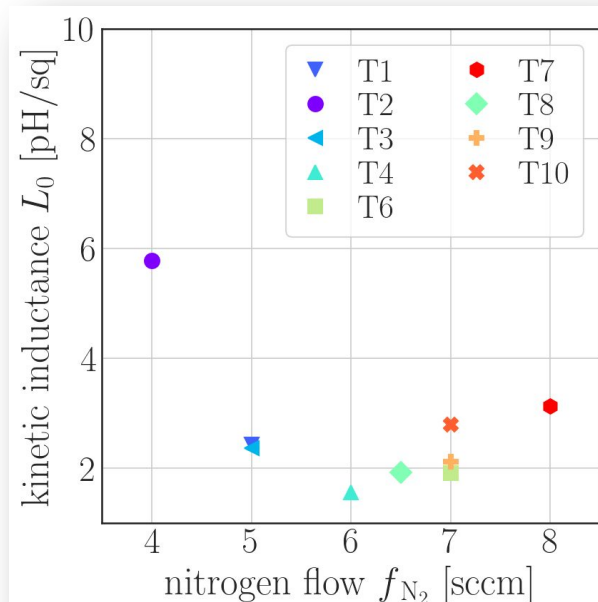
Sputter target:

$\text{Nb}_{80\%}\text{Ti}_{20\%}$



$$L_0 = \frac{R_S \cdot \hbar}{\pi \cdot T_C \cdot k_B \cdot 1.762}$$

✗ T10





Kinetic inductance devices:

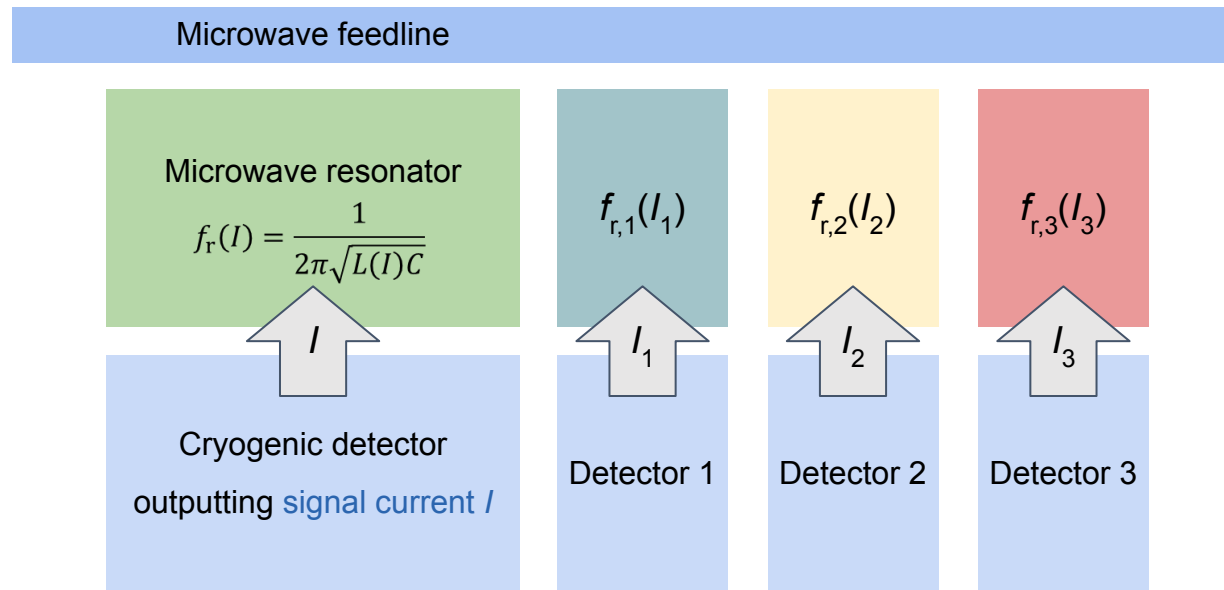
- Kinetic Inductance **Current Sensor** ([KICS](#))
- Travelling Wave Parametric **Amplifier** ([KI-TWPA](#))
- Travelling Wave Microwave **Photon Energy Lifter** ([KI-TWPEL](#))



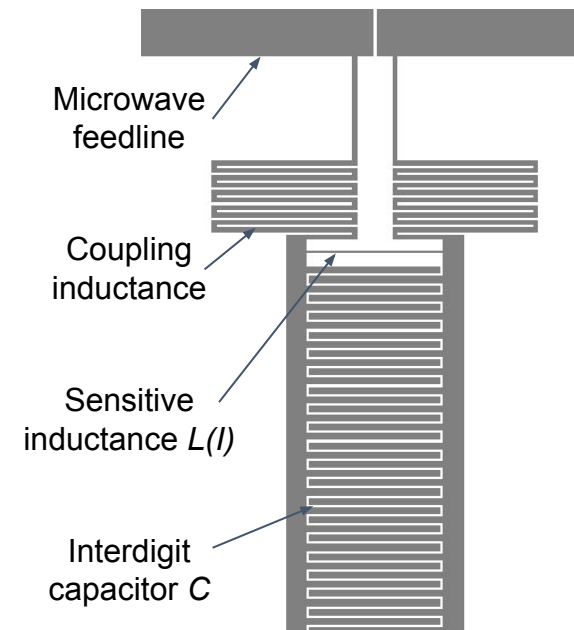
Kinetic Inductance Current Sensor (KICS)



Concept:



Prototype design:



Microfabricated device:

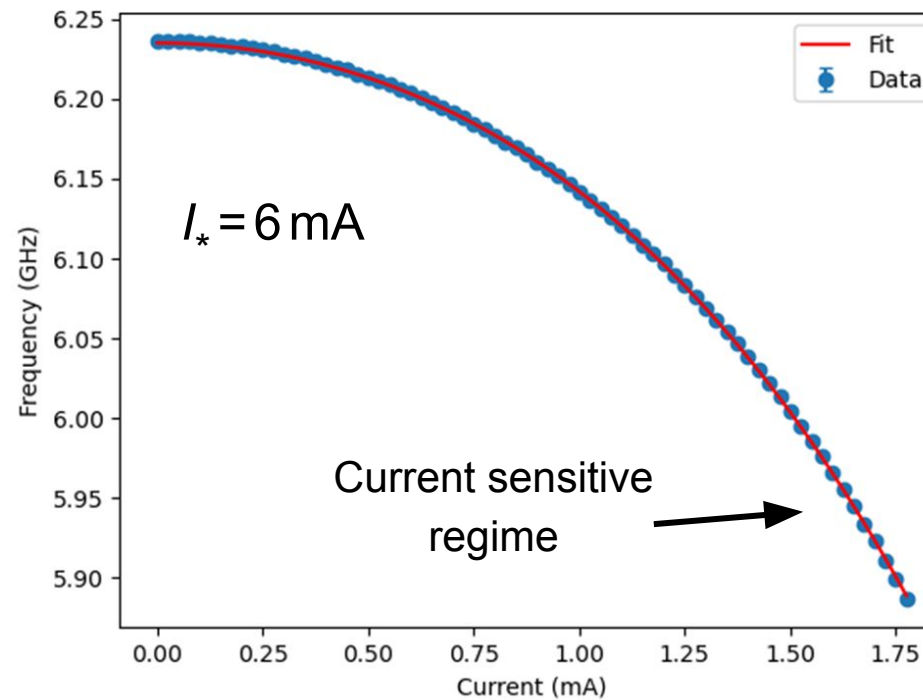
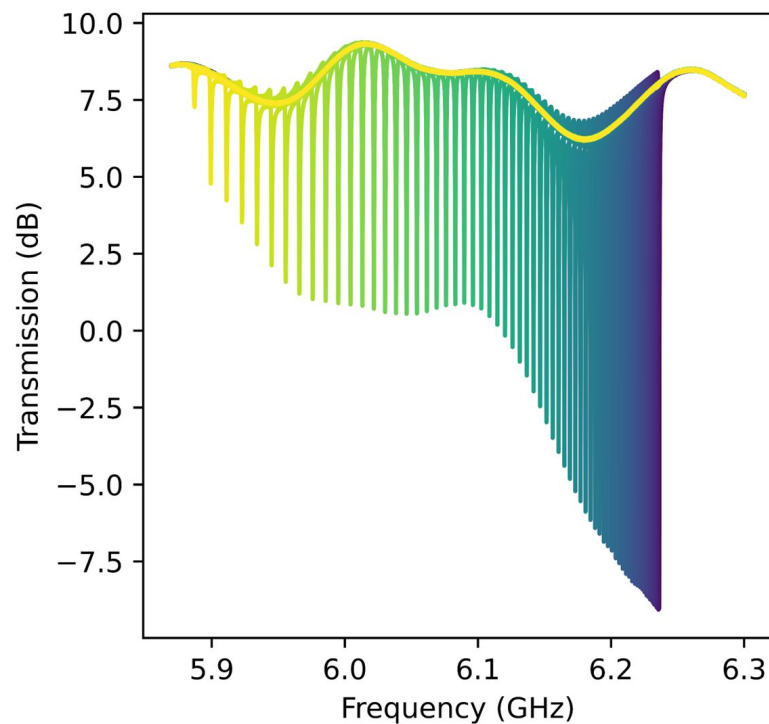


Idea: P. Szypryt et al., *Commun Eng* 3, 160 (2024)

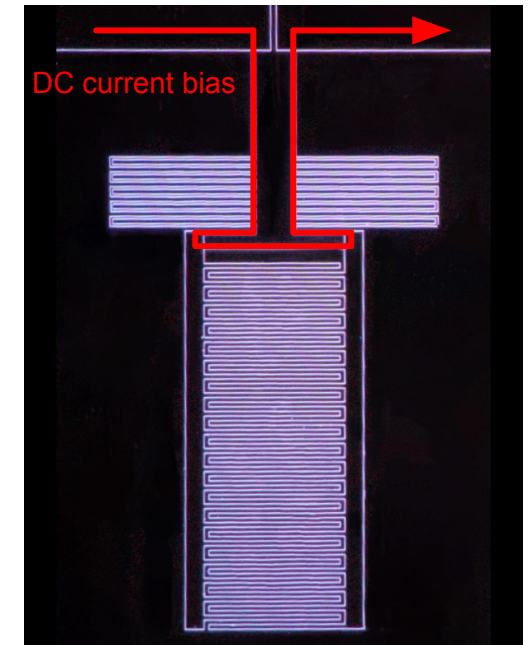


Kinetic Inductance Current Sensor (KICS)

Tunability of the resonance frequency:



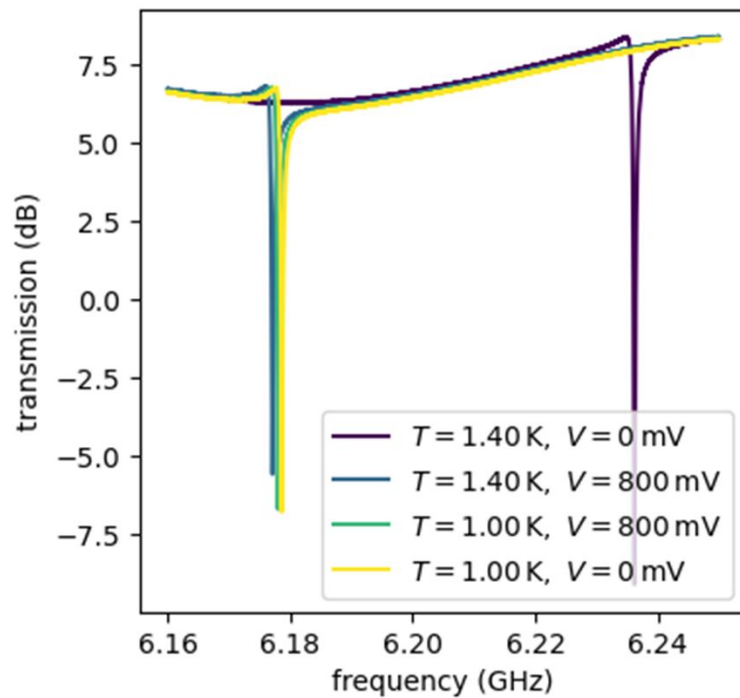
Microfabricated device:



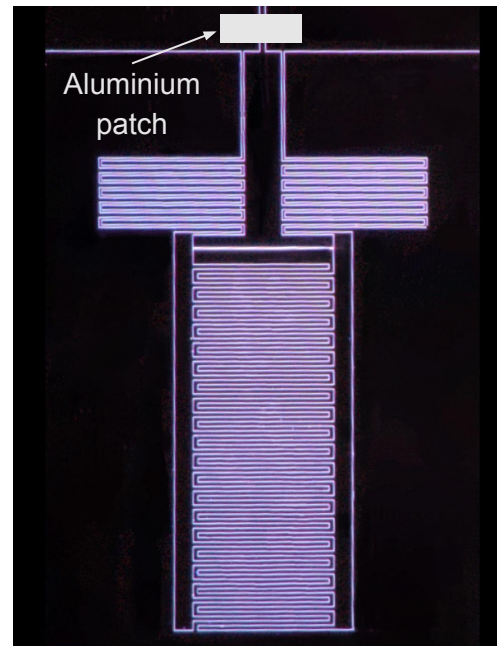


Kinetic Inductance Current Sensor (KICS)

Preparation of persistent supercurrent bias:

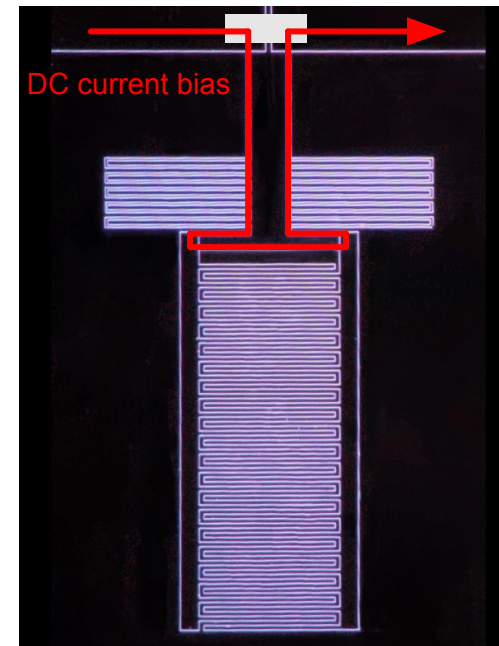


Step 1:



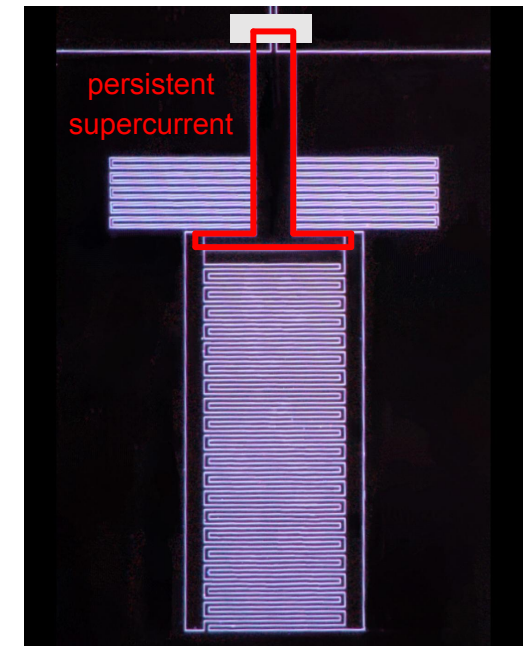
$$T_{\text{NbTiN}} > T > T_{\text{Al}}$$

Step 2 & step 3:



Apply bias, cool to $T < T_{\text{Al}}$

Step 4:



Remove external bias, $T < T_{\text{Al}}$



Kinetic Inductance Travelling Wave Parametric Amplifier (KI-TWPA)

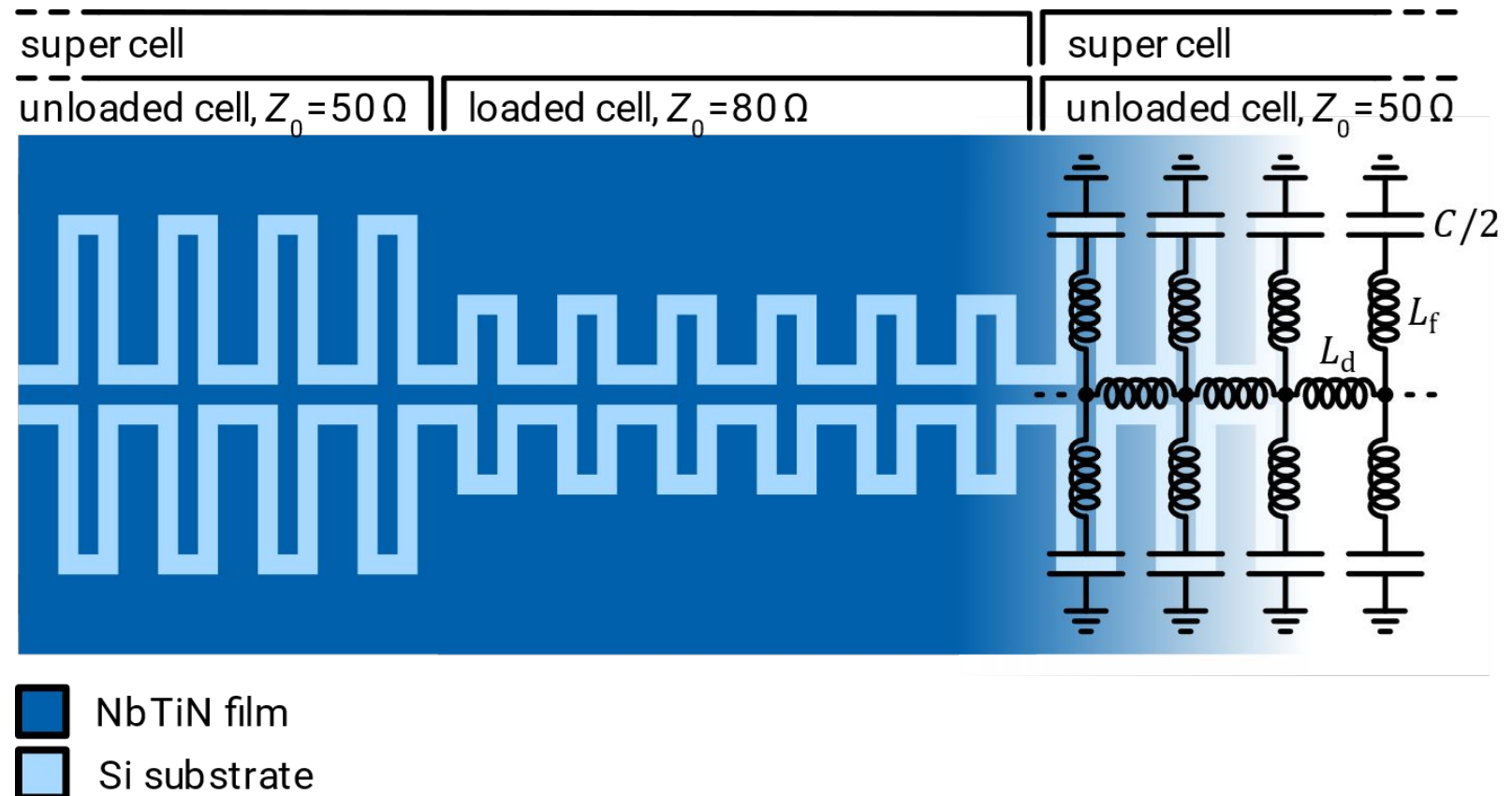
Weakly dispersive artificial transmission line:

Series of CPW sections (*cells*)
flanked by IDC fingers

⇒ *decrease phase velocity*

Phase-matching: *periodic*
increasing of the line *impedance*
(*loading*)

⇒ *stopband*





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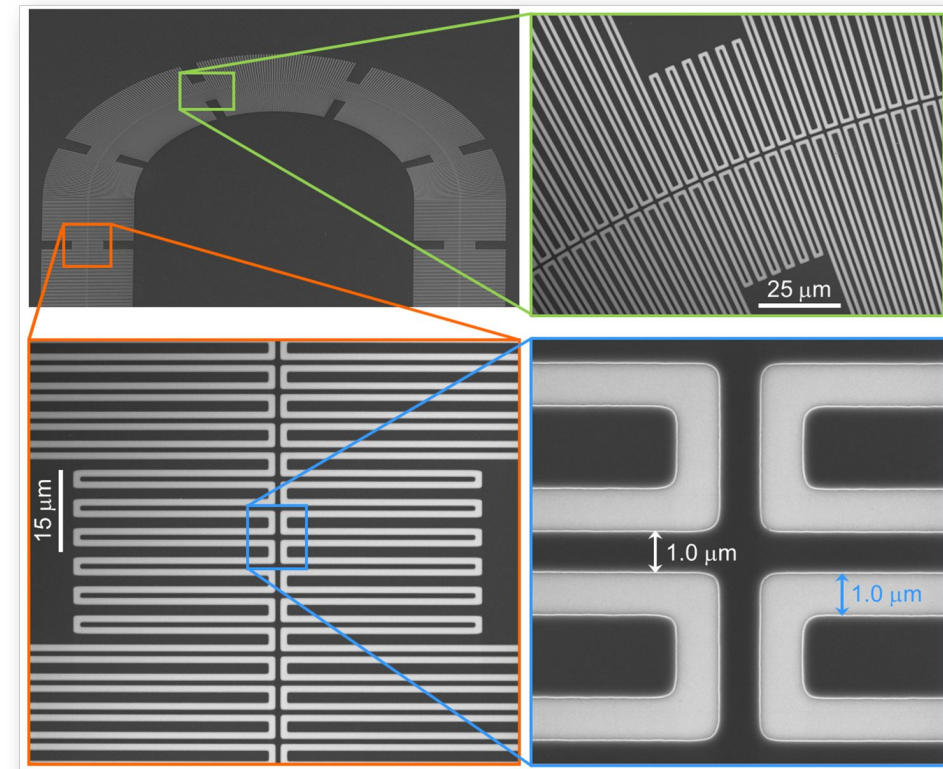
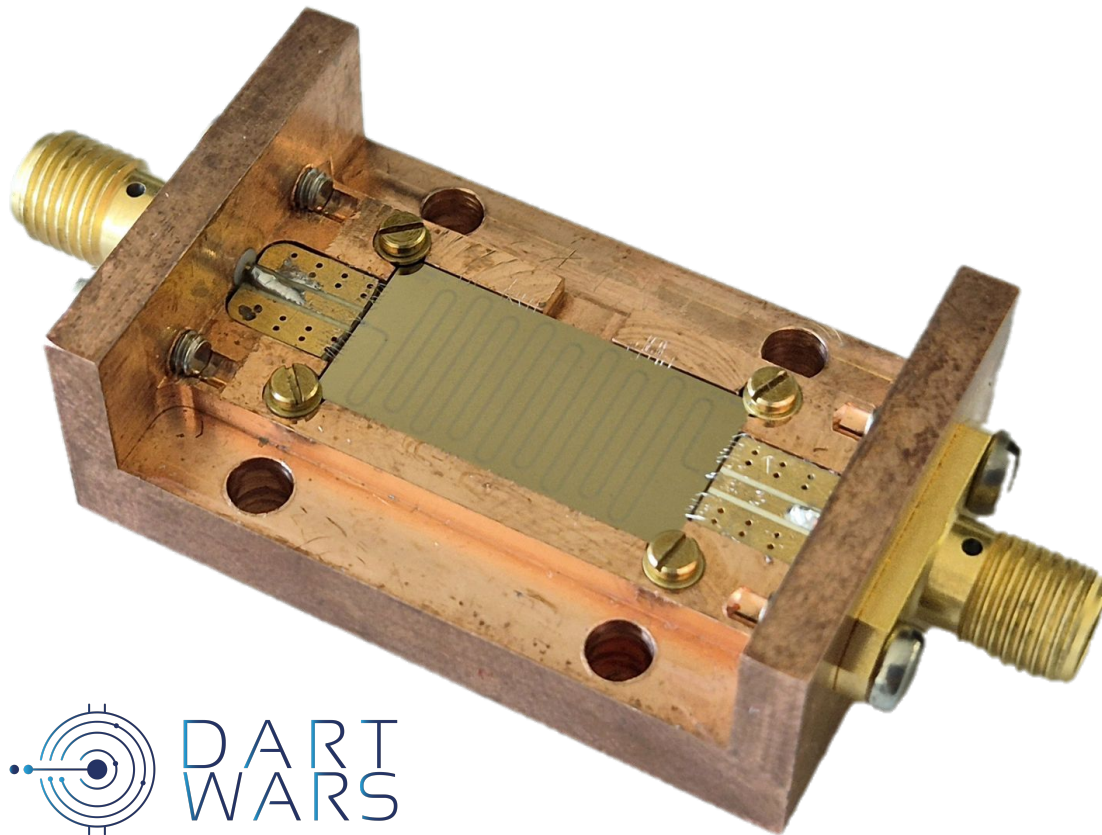


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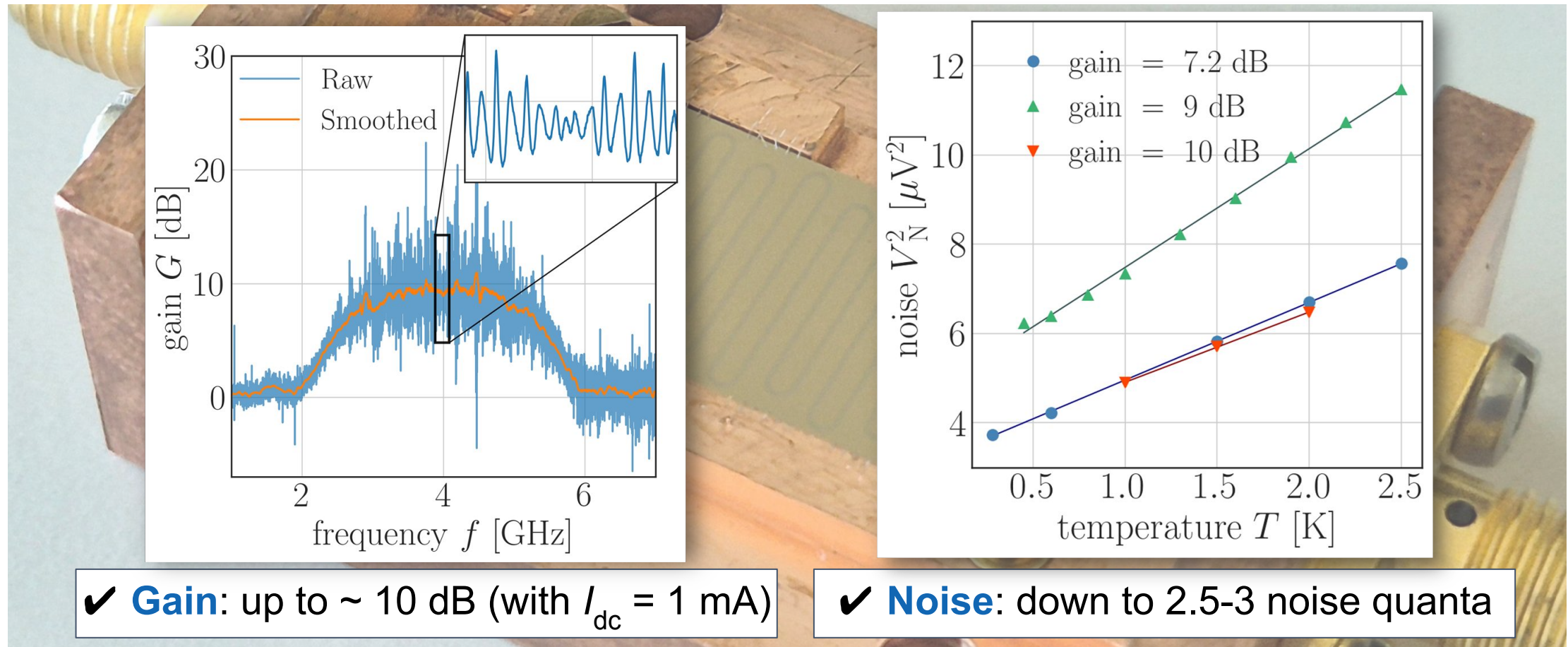
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Kinetic Inductance Travelling Wave Parametric Amplifier (KI-TWPA)





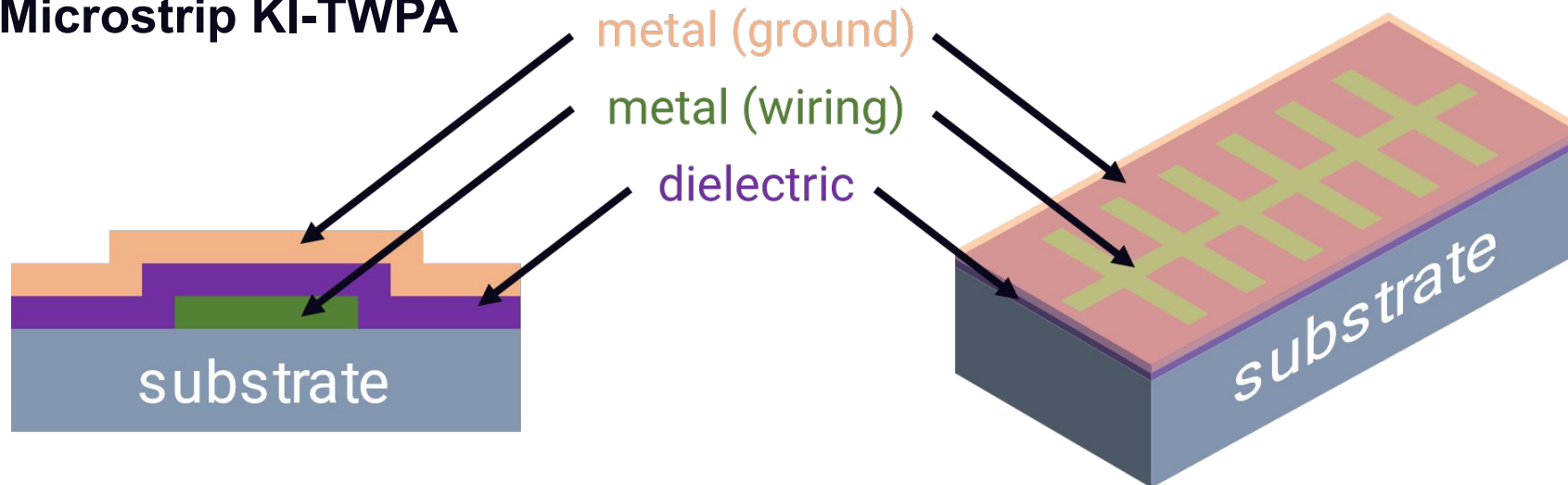
Kinetic Inductance Travelling Wave Parametric Amplifier (KI-TWPA)





Kinetic Inductance Travelling Wave Parametric Amplifier (KI-TWPA)

Microstrip KI-TWPA

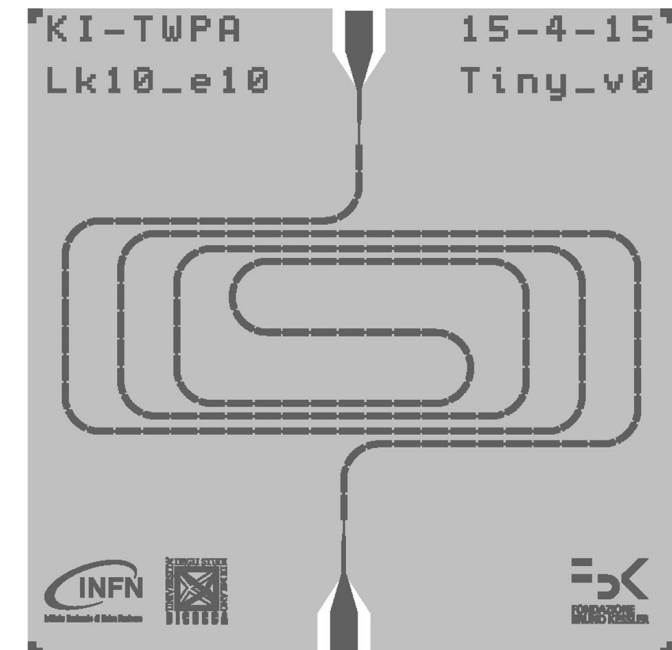


Advantages:

- More **compact** design
- Improved **grounding**
- High fabrication **yield**

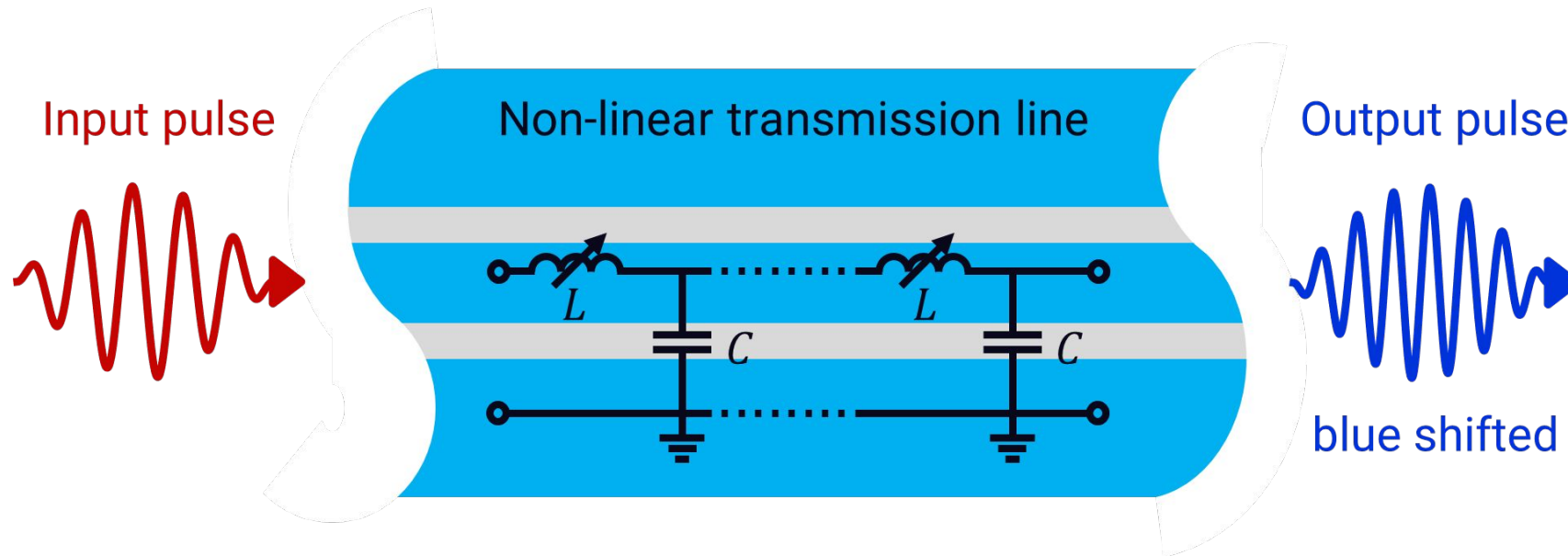
Challenges:

- Development of **low-loss dielectric**
 - PECVD **a-Si**
 - ALD **AlOx**
- **Increase** sheet kinetic **inductance**





Travelling wave photon energy lifter (TWPEL)



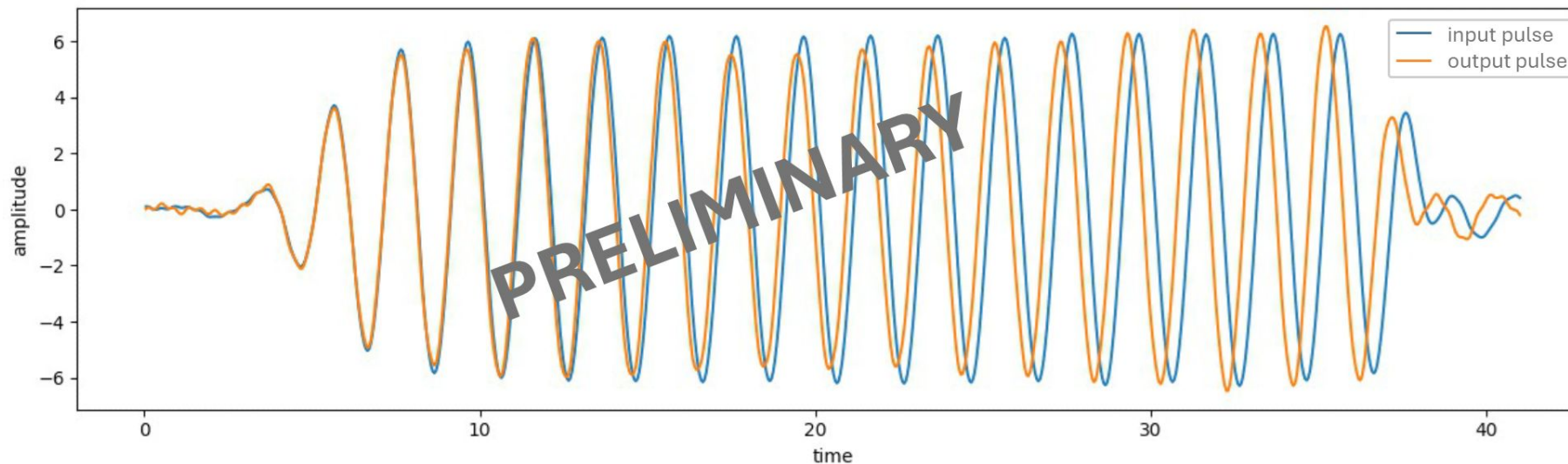
**PATENT IN
PREPARATION**

Advantages:

- Broadband
- Pulse shape preserving



Travelling wave photon energy lifter (TWPEL)



Advantages:

- Broadband
- Pulse shape preserving

Challenges:

- Dedicated dispersion engineering
- Sufficient tunability and non-linearity



Measurements
ongoing!



Conclusions

- **Kinetic inductance** materials: versatile tool for **many applications**
- Our kinetic inductance devices:
 - Current **sensors** (KICS)
 - Low-noise microwave **amplifiers** (KI-TWPA)
 - **Novel** microwave photon **energy lifter**

